

# **ER-OLED015-2 Series**

# **OLED Display Datasheet**





# EastRising Technology Co., Limited

- A. Some specifications of IC are not listed in this datasheet. Please refer to the IC datasheet for more details.
- B. The related documents for interfacing, demo code, ic datasheet are all available, please download from www.buydisplay.com.
- C. Please pay more attention to "Quality Control" in this Datasheet. We assume you already agree with these criterions when you place an order with us. No more recommendations.

REV	DESCRIPTION	RELEASE DATE
1.0	Preliminary Release	Jul-16-2013

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# **ORDERING INFORMATION**

# Order Number

Part Number(Order Number)	Description
ER-OLED015-2W	1.54" OLED Display Module in White Color
ER-OLED015-2B	1.54" OLED Display Module in Blue Color
ER-OLED015-2Y	1.54"OLED Display Module in Yellow Color
ER-DBO015-2	MCU 8051 Demo Board for ER-OLED015-2B Series Prodcuts

# Image







↑ ER-OLED015-2W

↑ ER-OLED015-2B

ER-OLED015-2Y

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## 1. Basic Specifications

### 1.1 Display Specifications

Display Mode: Passive Matrix
 Drive Duty: 1/64 Duty

### 1.2 Mechanical Specifications

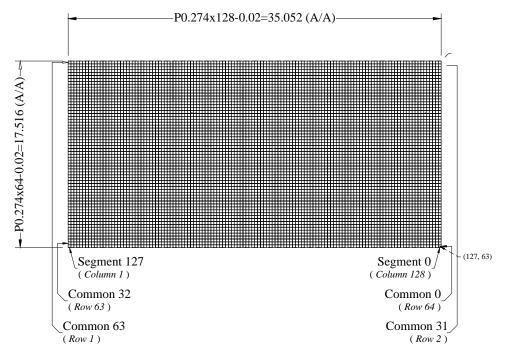
1) Outline Drawing: According to the annexed outline drawing

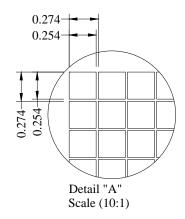
2) Number of Pixels:  $128 \times 64$ 

3) Panel Size: 42.04 × 27.22 × 1.45 (mm)
 4) Active Area: 35.052 × 17.516 (mm)
 5) Pixel Pitch: 0.274 × 0.274 (mm)
 6) Pixel Size: 0.254 × 0.254 (mm)

7) Weight: 3.28 (g)

## 1.3 Active Area / Memory Mapping & Pixel Construction



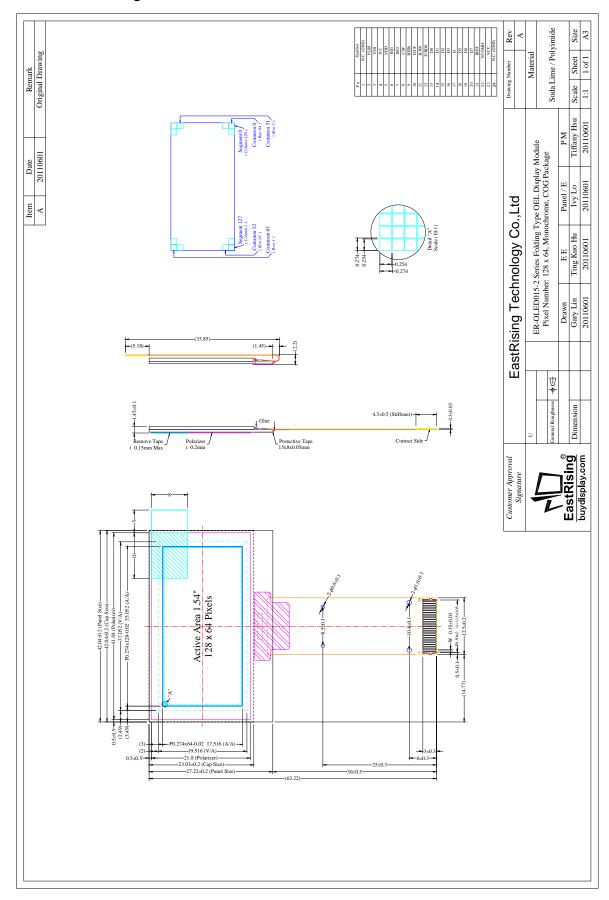


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## 1.4 Mechanical Drawing



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## 1.5 Pin Definition

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Pin Numbe	r Symbol	1/0	Function
Power Sup	pply		
5	VDD	Р	Power Supply for Logic Circuit This is a voltage supply pin. It must be connected to external source.
3	VSS	Р	Ground of Logic Circuit  This is a ground pin. It also acts as a reference for the logic pins. It must be connected to external ground.
23	VCC	Р	Power Supply for OEL Panel  This is the most positive voltage supply pin of the chip. It must be supplied externally.
2	VLSS	Р	Ground of Analog Circuit  This is an analog ground pin. It should be connected to V <sub>SS</sub> externally.
Driver			
21	IREF	I	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and $V_{SS}$ . Set the current at $10\mu A$ maximum.
22	VCOMH	0	Voltage Output High Level for COM Signal  This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and V <sub>SS</sub> .
Interface			
			Communicating Protocol Select These pins are MCU interface selection input. See the following table:
7	BS1 BS2		S1   BS2
9	RES#		Power Reset for Controller and Driver  This pin is reset signal input. When the pin is low, initialization of the chip is executed. Keep this pin pull high during normal operation.
8	CS#	I	Chip Select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.
10	D/C#	I	Data/Command Control  This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 will be interpreted as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register.  When the pin is pulled high and serial interface mode is selected, the data at SDIN will be interpreted as data. When it is pulled low, the data at SDIN will be transferred to the command register. In I²C mode, this pin acts as SA0 for slave address selection.  For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams.
12	E/RD#	I	Read/Write Enable or Read  This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low.  When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.  When serial or 1 <sup>2</sup> C mode is selected, this pin must be connected to V <sub>SS</sub> .
11	R/W#	I	Read/Write Select or Write  This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.  When serial or I²C mode is selected, this pin must be connected to Vss.



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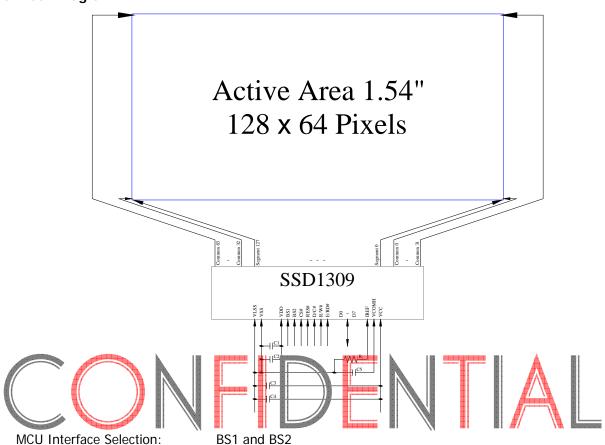
# 1.5 Pin Definition (Continued)

Pin Number	Pin Number Symbol I/O		Function
Interface (Co	ontinued)		
13~20 D0~D7 I/O microprocessor's data bus. When serial mode is selected, D1 will be the data input SDIN and D0 will be the serial clock input SCLK. When I²C r selected, D2, D1 should be tired together and serve as SDA <sub>OUT</sub> , SDA <sub>IN</sub> in app and D0 is the serial clock input, SCL.		These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I <sup>2</sup> C mode is selected, D2, D1 should be tired together and serve as SDA <sub>OUT</sub> , SDA <sub>IN</sub> in application	
Reserve			
4	N.C.	-	Reserved Pin  The N.C. pin between function pins are reserved for compatible and flexible design.
1, 24	N.C. (GND)	-	Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground as the ESD protection circuit.



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## 1.6 Block Diagram



MCU Interface Selection:

Pins connected to MCU interface: CS#, RES#, D/C#, R/W#, E/RD#, and D0~D7

C1, C3: 0.1µF C2: 4.7µF C4: 10µF

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4.7μF / 25V Tantalum Capacitor C5:

R1: 910k $\Omega$ , R1 = (Voltage at IREF - BGGND) / IREF



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# 2. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	$V_{DD}$	-0.3	4	V	1, 2
Supply Voltage for Display	$V_{CC}$	0	15	V	1, 2
Operating Temperature	T <sub>OP</sub>	-40	70	°C	3
Storage Temperature	T <sub>STG</sub>	-40	85	°C	3
Life Time (120 cd/m²)	•	8,000	-	hour	4
Life Time (80 cd/m²)		15,000	-	hour	4
Life Time (60 cd/m²)		25,000	-	hour	4

Note 1: All the above voltages are on the basis of " $V_{SS} = 0V$ ".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

Note 3: The defined temperature ranges do not include the polarizer. The maximum withstood

temperature of the polarizer should be 80°C.

Note 4: V<sub>CC</sub> = 12.5V, T<sub>a</sub> = 25 C, 50 6 Checkerboa d.

Software configuration follows Section 4.4 Initiality at the polarizer should be 80°C.

Initiality at the polarizer should be 80°C.

Software configuration follows Section 4.4 Initiality hess reached. room temperature is stim ted by the accelerated operation at high temperature conditions

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# 3. Optics & Electrical Characteristics

## 3.1 Optics Characteristics in White Color

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Brightness	L <sub>br</sub>	Note 5	100	120	-	cd/m <sup>2</sup>
C.I.E. (White)	(x) (y)	C.I.E. 1931	0.12 0.22	0.16 0.26	0.20 0.30	
Dark Room Contrast	CR		-	>10,000:1	-	
Viewing Angle			-	Free	-	degree

<sup>\*</sup> Optical measurement taken at  $V_{DD}=2.8V,\ V_{CC}=12.5V.$ Software configuration follows Section 4.4 Initialization.

### 3.2 DC Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Logic	$V_{DD}$		1.65	2.8	3.3	V
Supply Voltage for Display	$V_{\text{CC}}$	Note 5	12.0	12.5	13.0	V
high Level Input	A <sup>(H</sup>	L <sub>OUT</sub> = 100 IA, 3.3MHz	7.8×V <sub>D</sub>	-	Von	V
Low Level Input	V <sub>I</sub> L	<b>L<sub>OUT</sub> = 100μ λ, <mark>3.3MH</mark>z</b>	0	-	0.2×V <sub>DD</sub>	V
High Level Output	V <sub>он</sub>	<b>Ι</b> <sub>ουτ</sub>	0.9×. <sub>D</sub>	-	V <sub>DD</sub>	V
Low Level Output	V <sub>OL</sub>	$I_{OUT} = 100\mu A, 3.3MHz$	0 "	-	0.1×V <sub>DD</sub>	V
Operating Current for V <sub>DD</sub>	I <sub>DD</sub>		-	180	300	μΑ
		Note 6	-	11.8	14.8	mA
Operating Current for $V_{\text{CC}}$	$I_{CC}$	Note 7	-	19.1	23.9	mA
		Note 8	-	35.6	44.5	mA
Sleep Mode Current for $V_{\text{DD}}$	I <sub>DD, SLEEP</sub>		-	1	5	μΑ
Sleep Mode Current for V <sub>CC</sub>	I <sub>CC, SLEEP</sub>		-	2	10	μΑ

Note 5: Brightness  $(L_{br})$  and Supply Voltage for Display  $(V_{CC})$  are subject to the change of the panel characteristics and the customer's request.

Note 6:  $V_{DD}$  = 2.8V,  $V_{CC}$  = 12.5V, 30% Display Area Turn on.

Note 7:  $V_{DD} = 2.8V$ ,  $V_{CC} = 12.5V$ , 50% Display Area Turn on.

Note 8:  $V_{DD} = 2.8V$ ,  $V_{CC} = 12.5V$ , 100% Display Area Turn on.

<sup>\*</sup> Software configuration follows Section 4.4 Initialization.

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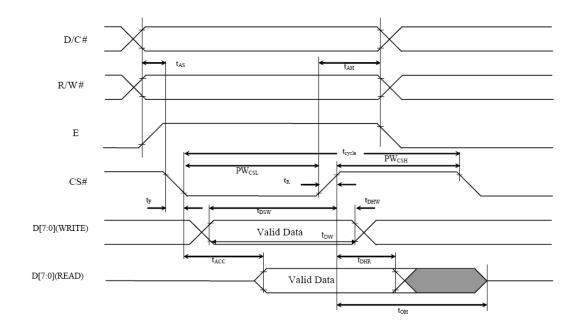
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## 3.3 AC Characteristics

3.3.1 68XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	300	-	ns
t <sub>AS</sub>	Address Setup Time	20	-	ns
t <sub>AH</sub>	Address Hold Time	0	-	ns
t <sub>DW</sub>	Data Write Time	80	-	ns
t <sub>DSW</sub>	Write Data Setup Time	40	-	ns
t <sub>DHW</sub>	Write Data Hold Time	20	-	ns
t <sub>DHR</sub>	Read Data Hold Time	20	_	ns
t <sub>OH</sub>	Output Disable Time	_	70	ns
t <sub>ACC</sub>	Access Time	_	140	ns
DW	Chip Select Low Pulse Width (Read)	120		
PW <sub>CSL</sub>	Chip Select Low Pulse width (Write)	60	-	ns
DW	Chip Select High Pulse Width (Read)	60	<u> </u>	
PWcsH	Chip elect ligh Pulse Wic h (We'te)	60		ns
t <sub>R</sub>	Rise i ima	-	40 40	ns ns

\* ( $V_{DD}$  -  $V_{SS}$  = 1.65V to 3.3V,  $T_a$  = 25°C)

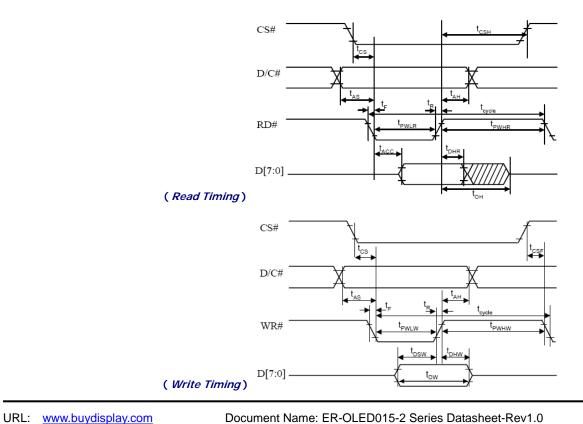




# 3.3.2 80XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	300	-	ns
t <sub>AS</sub>	Address Setup Time	20	-	ns
t <sub>AH</sub>	Address Hold Time	0	-	ns
t <sub>DW</sub>	Data Write Time	70	-	ns
t <sub>DSW</sub>	Write Data Setup Time	40	-	ns
t <sub>DHW</sub>	Write Data Hold Time	15	-	ns
t <sub>DHR</sub>	Read Data Hold Time	20	-	ns
t <sub>OH</sub>	Output Disable Time	-	70	ns
t <sub>ACC</sub>	Access Time	-	140	ns
t <sub>PWLR</sub>	Read Low Time	120	-	ns
t <sub>PWLW</sub>	Write Low Time	60	-	ns
$t_{\sf PWHR}$	Read High Time	60	-	ns
t <sub>PWHW</sub>	Write High Time	60	-	ns
es	Chip Nect etup Time	0		ns
t <sub>CSH</sub>	Chip select lold Time to Fead Signal	0		ns
tcs	Chip select lold Time	20	<b>/</b> / - \	l <sub>ns</sub>
t <sub>R</sub>	Rise Time	_	40	ns
t <sub>F</sub>	Fall Time	-	40	ns

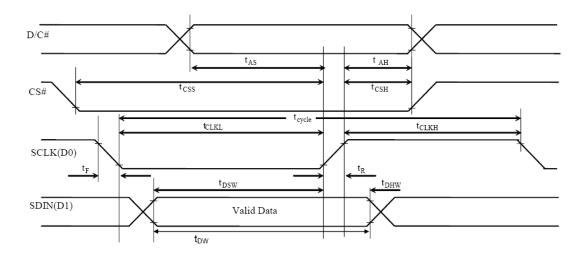
<sup>\*</sup>  $(V_{DD} - V_{SS} = 1.65V \text{ to } 3.5V, T_a = 25^{\circ}C)$ 

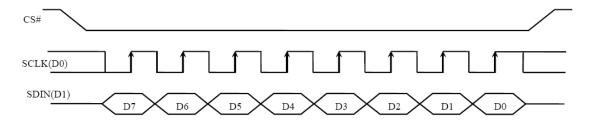


3.3.3 Serial Interface Timing Characteristics: (4-wire SPI)

Symbol	Description	Min	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	100	-	ns
t <sub>AS</sub>	Address Setup Time	15	-	ns
t <sub>AH</sub>	Address Hold Time	15	-	ns
t <sub>CSS</sub>	Chip Select Setup Time	20	-	ns
t <sub>CSH</sub>	Chip Select Hold Time	50	-	ns
$t_{DW}$	Data Write Time	55	-	ns
t <sub>DSW</sub>	Write Data Setup Time	15	-	ns
t <sub>DHW</sub>	Write Data Hold Time	15	-	ns
t <sub>CLKL</sub>	Clock Low Time	50	-	ns
t <sub>CLKH</sub>	Clock High Time	50	-	ns
$t_R$	Rise Time	-	40	ns
t <sub>F</sub>	Fall Time	-	40	ns

<sup>\* (</sup> $V_{DD}$  -  $V_{SS}$  = 1.65V to 3.5V,  $T_a$  = 25°C)

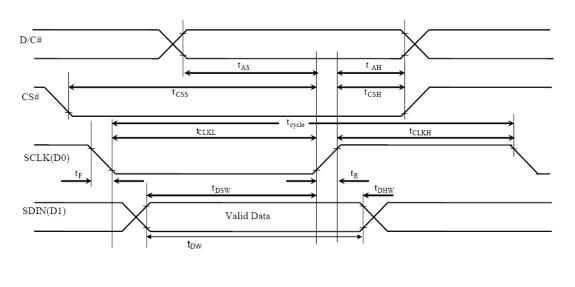


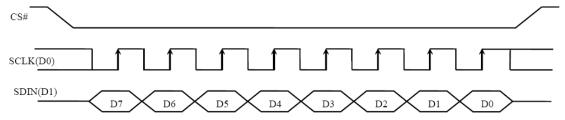


3.3.4 Serial Interface Timing Characteristics: (3-wire SPI)

Symbol	Description	Min	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	100	-	ns
t <sub>AS</sub>	Address Setup Time	15	-	ns
t <sub>AH</sub>	Address Hold Time	15	-	ns
t <sub>CSS</sub>	Chip Select Setup Time	20	-	ns
t <sub>CSH</sub>	Chip Select Hold Time	50	-	ns
t <sub>DW</sub>	Data Write Time	55	-	ns
t <sub>DSW</sub>	Write Data Setup Time	15	-	ns
t <sub>DHW</sub>	Write Data Hold Time	15	_	ns
t <sub>CLKL</sub>	Clock Low Time	50	_	ns
t <sub>CLKH</sub>	Clock High Time	50	-	ns
t <sub>R</sub>	Rise Time	-	40	ns
t <sub>F</sub>	Fall Time	-	40	ns

<sup>\*</sup>  $(V_{DD} - V_{SS} = 1.65V \text{ to } 3.5V, T_a = 25^{\circ}C)$ 





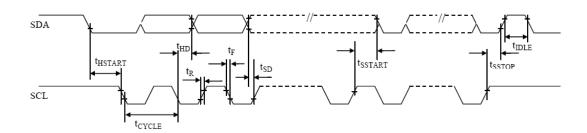
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# 3.3.5 I<sup>2</sup>C Interface Timing Characteristics:

Symbol	Description		Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	2.5	-	μs
t <sub>HSTART</sub>	Start Condition Hold Time	0.6	-	μs
+	Data Hold Time (for "SDA <sub>OUT</sub> " Pin)			
t <sub>HD</sub>	Data Hold Time (for "SDA <sub>IN</sub> " Pin)	300	-	ns
t <sub>SD</sub>	Data Setup Time	100	-	ns
t <sub>SSTART</sub>	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	μs
t <sub>SSTOP</sub>	Stop Condition Setup Time	0.6	-	μs
$t_R$	Rise Time for Data and Clock Pin		300	ns
t <sub>F</sub>	Fall Time for Data and Clock Pin		300	ns
t <sub>IDLE</sub>	Idle Time before a New Transmission can Start	1.3	-	μs

<sup>\*</sup>  $(V_{DD} - V_{SS} = 1.65V \text{ to } 3.5V, T_a = 25^{\circ}C)$ 





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## 4. Functional Specification

### 4.1 Commands

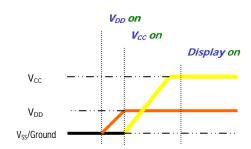
Refer to the Technical Manual for the SSD1309

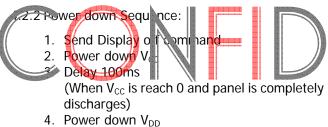
### 4.2 Power down and Power up Sequence

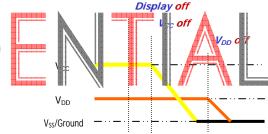
To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.

### 4.2.1 Power up Sequence:

- 1. Power up V<sub>DD</sub>
- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5. Power up V<sub>CC</sub>
- 6. Delay 100ms (When V<sub>CC</sub> is stable)
- 7. Send Display on command







### Note 9:

- 1) Since an ESD protection circuit is connected between  $V_{DD}$  and  $V_{CC}$  inside the driver IC,  $V_{CC}$  becomes lower than  $V_{DD}$  whenever  $V_{DD}$  is ON and  $V_{CC}$  is OFF.
- 2) V<sub>CC</sub> should be kept float (disable) when it is OFF.
- 3) Power Pins (V<sub>DD</sub>, V<sub>CC</sub>) can never be pulled to ground under any circumstance.
- 4)  $V_{DD}$  should not be power down before  $V_{CC}$  power down.

### 4.3 Reset Circuit

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When RES# input is low, the chip is initialized with the following status:

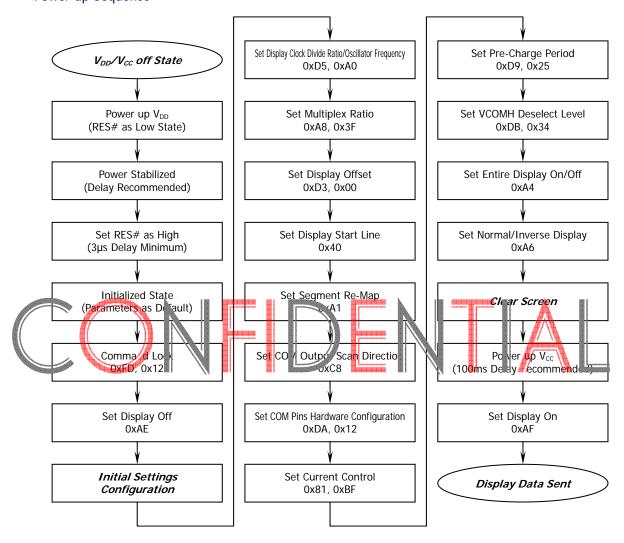
- 1. Display is OFF
- 2. 128×64 Display Mode
- 3. Normal segment and display data column and row address mapping (SEG0 mapped to column address 00h and COM0 mapped to row address 00h)
- 4. Shift register data clear in serial interface
- 5. Display start line is set at display RAM address 0
- 6. Column address counter is set at 0
- 7. Normal scan direction of the COM outputs
- 8. Contrast control register is set at 7Fh
- 9. Normal display mode (Equivalent to A4h command)

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## 4.4 Actual Application Example

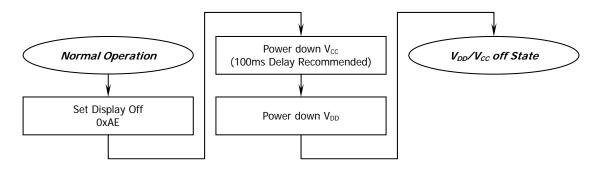
Command usage and explanation of an actual example

### <Power up Sequence>



If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

### <Power down Sequence>

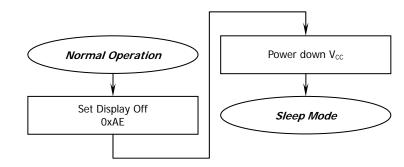




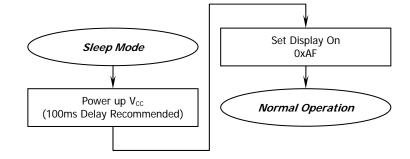
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# <Entering Sleep Mode>



## <Exiting Sleep Mode>





# 5. Reliability

## 5.1 Contents of Reliability Tests

Item	Conditions	Criteria	
High Temperature Operation	70°C, 240 hrs		
Low Temperature Operation	-40°C, 240 hrs		
High Temperature Storage	85°C, 240 hrs	The operational	
Low Temperature Storage	-40°C, 240 hrs	functions work.	
High Temperature/Humidity Operation	60°C, 90% RH, 120 hrs		
Thermal Shock	-40°C ⇔ 85°C, 24 cycles 60 mins dwell		

<sup>\*</sup> The samples used for the above tests do not include polarizer.

### 5.2 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at  $23\pm5^{\circ}$ C;  $55\pm15\%$  RH.

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<sup>\*</sup> No moisture condensation is observed during tests.



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# 6. QUALITY CONTROL

### 6.1 EastRising Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature:  $23\pm5^{\circ}$ C

Humidity:  $55\pm15\%$  RH

Fluorescent Lamp: 30W
Distance between the Panel & Lamp: ≥50cm
Distance between the Panel & Eyes of the Inspector: ≥30cm

Finger glove (or finger cover) must be worn by the inspector.

Inspection table of jig must be anti-electrostatic.

## 6.2 EastRising OLED Display Criteria & Acceptable Quality Level

Partition	AQL	Definition	
Major	0.65	Defects in Pattern Check (Display On)	
Minor	1.0	Defects in Cosmetic Check (Display Off)	

### 6.2.1 EastRising Cosmetic Check (Display Off) in Non-Active Area

Check Item	Classification	Criteria
Check Item Panel General Chipping	Classification	X>6mm (Along with Edge) Y>1mm (Perpendicular to edge)
		Y

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# 6.2.2 EastRising Cosmetic Check (Display Off)in Non-Active Area (Continued)

Check Item	Classification	Criteria
Panel Crack	Minor	Any crack is not allowable
Copper Exposed (Even Pin or Film)	Minor	Not Allowable by Naked Eye Inspection
Film or Trace Damage	Minor	O. W
Termial Lead Prober Mark	Acceptable	
Glue or Contamination on Pin	Minor	
Ink marking on Back Side of Panel (Exclude on Film)	Acceptable	Ignore for Any



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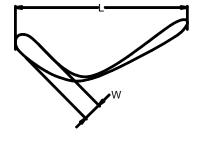
# 6.2.3 EastRising Cosmetic Check (Display Off) in Active Area

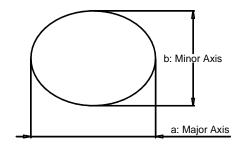
EastRising recommends to execute in clear environment (class 10k) if actual in necessary.

Check Item	Classification	Criteria	
Any Dirt & Scratch on Polarizer's Protective Film Accepta		Ignore for not Affect the Polarizer	
Scratches,Fiber,Line-Shape Defect (On Polarizer)	Minor	W≤0.1 W>0.1 L≤2 L>2	lgnore n≤1 n=0
Dirt, Black Spot, Foreign Material (On Polarizer)	Minor	Φ≤0.1 0.1<Φ≤0.25 0.25<Φ	Ignore n≤1 n=0
Dent,Bubbles,White Spot (Any Transparent Spot on Polarizer)	Minor	Φ≤0.5 Ignore if no Influence 0.5<Φ n=0	e on Display
Fingerpint ,Flow Mark (On Polarizer)	Minor	Not Allowal	ble

<sup>\*</sup> Protective film should not be tear off when cosmetic check.

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<sup>\*</sup> Definition of W & L &Φ(Unit:mm): Φ=(a+b)/2

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# 6.2.4 EastRising Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	
Un-uniform	Major	



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## 7.PRECAUTIONS for USING

- 7.1 Handling Precautions
- 1) Since the EastRiisng OLED display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the EastRising OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- 5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the polarizer:
  - \* Water
  - \* Ketone
  - \* Aromatic Solvents
- 6) Hold EastRising OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.
- 7) Do not apply stress to the driver IC and the surrounding molded sections.
- 8) Do not disassemble nor modify the OLED display module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing EastRising OLED display modules to prevent occurrence of element breakage accidents by static electricity.
  - \* Be sure to make human body grounding when handling OLED display modules.
  - \* Be sure to ground tools to use or assembly such as soldering irons.
  - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

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- \* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the EastRising OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

## 7.2 Storage Precautions

- 1) When storing EastRising OLED display modules, put them in static electricity preventive bags avoiding exposure neither to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from EastRising.) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

### 7.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OLED display module, fasten the external plastic housing section.

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- 7) If power supply to the EastRising OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- 7.4 Precautions when disposing of the EastRising OLED display modules
- Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

### 7.5 Other Precautions

- 1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- 2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
  - \* Pins and electrodes
  - \* Pattern layouts such as the FPC
- 3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
  - \* Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
  - \* Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- 4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

That's the end of the datasheet.

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